Docket No.: 135371 (1306-40)



licants:

Slawomir RUBINSZTAJN, et al.

Serial No:

10/654,378

Filed:

September 3, 2003

For:

SOLVENT-MODIFIED RESIN SYSTEM

CONTAINING FILLER THAT HAS HIGH

Tg, TRANSPARENCY AND GOOD RELIABILITY IN WAFER LEVEL UNDERFILL APPLICATIONS Dated: November 25, 2003

Commissioner for Patents P.O. Box 1450 Alexandria, New York 22313-1450

CHANGE OF ATTORNEY'S ADDRESS IN APPLICATION

Please send all corresponce and direct all telephone calls for this application as follows:

GE Global Research Docket Room K-1/4A59 One Research Circle Niskayuna, New York 12309

Respectfully submitted,

Raymond E. Farrell Reg. No. 34, 816

Agent for Applicant(s)

Raymond E. Farrell, Esq.
CARTER, DELUCA, FARRELL & SCHMIDT, LLP
445 Broad Hollow Raod – Suite 225
Melville, New York 11747
(631) 501-5706

REF: jjp

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail, postpaid in an envelope, addressed to the: Commissioner for Patents, P.O. Box 1450, Alexandria, New York 22313-1450 on November 25, 2003.

Dated: November 25, 2003

Raymond E. Farrell